



High power cycling capability
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Thyristor Type T173-2500-18

Mean on-state current			I _{TAV}	2500 A				
Repetitive peak off-state voltage			V _{DRM}	1000 ÷ 1800 V				
Repetitive peak reverse voltage			V _{RRM}					
Turn-off time			t _q	250, 320, 400, 500 µs				
V _{DRM} , V _{RRM} , V	1000	1100	1200	1300	1400	1500	1600	1800
Voltage code	10	11	12	13	14	15	16	18
T _j , °C	-60 ÷ 125							

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters			Units	Values	Test conditions		
ON-STATE							
I _{TAV}	Mean on-state current	A	2500 3158	T _c =95 °C, Double side cooled T _c =85 °C, Double side cooled 180° half-sine wave; 50 Hz			
I _{TRMS}	RMS on-state current	A	3925	T _c =95 °C, Double side cooled 180° half-sine wave; 50 Hz			
I _{TSM}	Surge on-state current	kA	69.0 79.0	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs		
			72.0 83.0	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs		
I ² t	Safety factor	A ² ·10 ³	23800 31200	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =10 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs		
			21500 28500	T _j =T _j max T _j =25 °C	180° half-sine wave; t _p =8.3 ms; single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 µs; di _G /dt≥1 A/µs		
BLOCKING							
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000÷1800	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz; Gate open			
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100÷1900	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; single pulse; Gate open			
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.6V _{DRM} 0.6V _{RRM}	T _j =T _j max; Gate open			

TRIGGERING				
I_{FGM}	Peak forward gate current	A	10	$T_j=T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	5	$T_j=T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	2000	$T_j=T_{j \max}$; $V_D=0.67V_{DRM}$; $I_{TM}=6400$ A; Gate pulse: $I_G=2$ A; $t_{GP}=50$ μ s; $di_G/dt \geq 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60÷50	
T_j	Operating junction temperature	°C	-60÷125	
MECHANICAL				
F	Mounting force	kN	40.0÷50.0	
a	Acceleration	m/s ²	50	Device clamped

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
V_{TM}	Peak on-state voltage, max	V	1.55	$T_j=25$ °C; $I_{TM}=7850$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	0.909	$T_j=T_{j \max}$;
r_T	On-state slope resistance, max	$m\Omega$	0.075	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
I_L	Latching current, max	mA	1500	$T_j=25$ °C; $V_D=12$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ μ s; $di_G/dt \geq 1$ A/ μ s
I_H	Holding current, max	mA	300	$T_j=25$ °C; $V_D=12$ V; Gate open
BLOCKING				
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j=T_{j \max}$; $V_D=V_{DRM}$; $V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j=T_{j \max}$; $V_D=0.67V_{DRM}$; Gate open
TRIGGERING				
V_{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
I_{GT}	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j \min}$ $T_j=25$ °C $T_j=T_{j \max}$
V_{GD}	Gate non-trigger direct voltage, min	V	0.35	$T_j=T_{j \max}$;
I_{GD}	Gate non-trigger direct current, min	mA	30.00	$V_D=0.67V_{DRM}$; Direct gate current
SWITCHING				
t_{gd}	Delay time, max	μ s	0.90	$T_j=25$ °C; $V_D=1000$ V; $I_{TM}=I_{TAV}$; $di/dt=200$ A/ μ s;
t_{gt}	Turn-on time	μ s	3.00	Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ μ s; $di_G/dt=2$ A/ μ s
t_q	Turn-off time ²⁾ , max	μ s	250, 320, 400, 500	$dv_D/dt=50$ V/ μ s; $T_j=T_{j \max}$; $I_{TM}=I_{TAV}$; $di_R/dt=-10$ A/ μ s; $V_R=100$ V; $V_D=0.67V_{DRM}$
Q_{rr}	Total recovered charge, max	μ C	2970	$T_j=T_{j \max}$; $I_{TM}=1600$ A;
t_{rr}	Reverse recovery time, max	μ s	29	$di_R/dt=-10$ A/ μ s;
I_{rrM}	Peak reverse recovery current, max	A	205	$V_R=100$ V

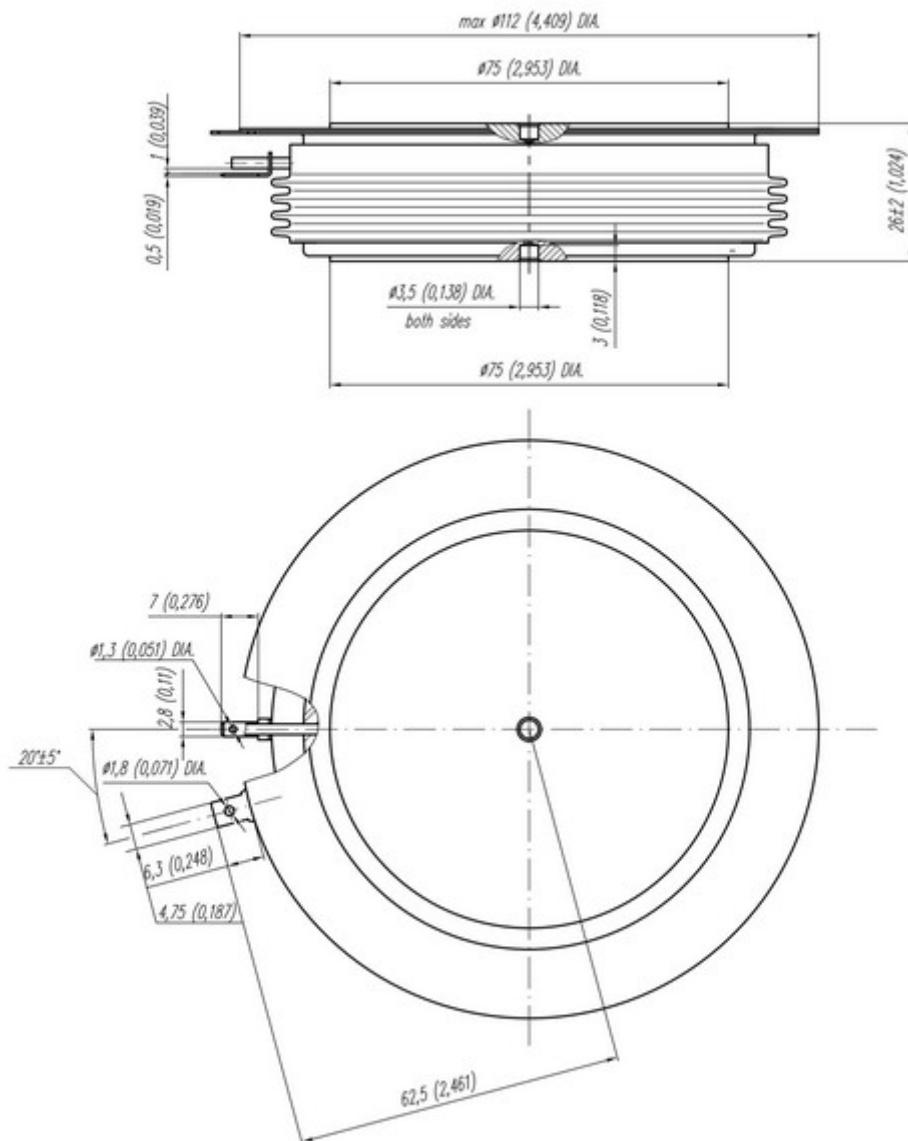
THERMAL						
R_{thjc}	Thermal resistance, junction to case, max		$^{\circ}\text{C}/\text{W}$	0.0085	Direct current	Double side cooled
R_{thjc-A}				0.0187		Anode side cooled
R_{thjc-K}				0.0153		Cathode side cooled
R_{thck}	Thermal resistance, case to heatsink, max		$^{\circ}\text{C}/\text{W}$	0.0020	Direct current	

MECHANICAL						
W	Weight, max		g	1500		
D_s	Surface creepage distance		mm (inch)	36.60 (1.441)		
D_a	Air strike distance		mm (inch)	16.20 (0.638)		

PART NUMBERING GUIDE							NOTES													
T	173	2500	18	A2	E2	N														
1	2	3	4	5	6	7														
1. Phase Control Thyristor																				
2. Design version																				
3. Mean on-state current, A																				
4. Voltage code																				
5. Critical rate of rise of off-state voltage, V/ μs																				
6. Turn-off time ($\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$)																				
7. Ambient conditions: N – normal; T – tropical																				
							1) Critical rate of rise of off-state voltage													
							Symbol of Group	P2	K2	E2	A2	T1	P1	M1						
							$(\text{dv}_D/\text{dt})_{\text{crit}}, \text{V}/\mu\text{s}$	200	320	500	1000	1600	2000	2500						
							2) Turn-off time ($\text{dv}_D/\text{dt}=50 \text{ V}/\mu\text{s}$)													
							Symbol of Group	M2	K2	H2	E2									
							$t_{\text{q}}, \mu\text{s}$	250	320	400	500									

OVERALL DIMENSIONS

Package type: T.F2



All dimensions in millimeters (inches)

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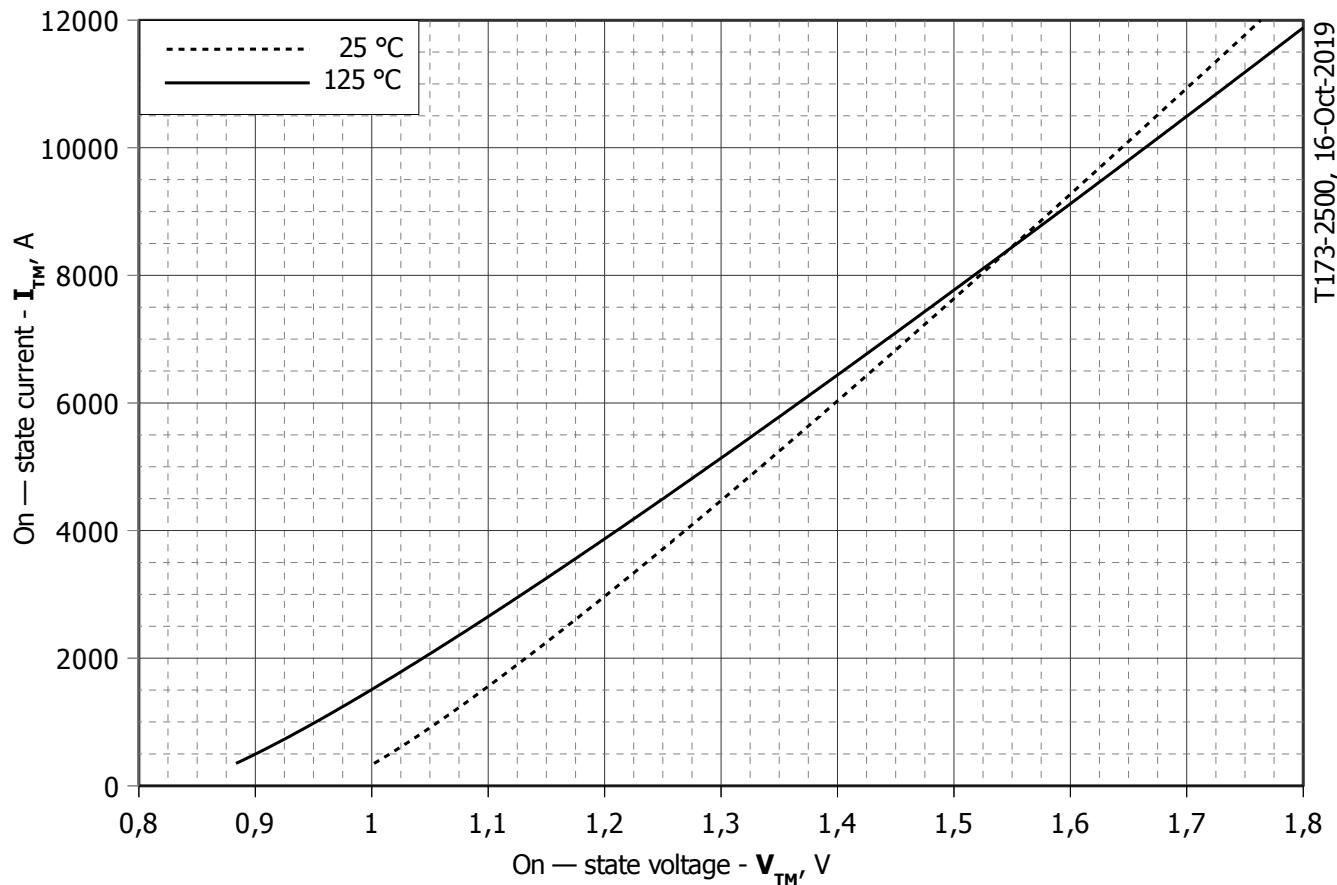


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25\text{ }^{\circ}\text{C}$	$T_j = T_{j,\max}$
A	0.976510000	0.844860000
B	0.000049556	0.000059368
C	-0.005807600	-0.005890600
D	0.002254800	0.002798800

On-state characteristic model (see Fig. 1)

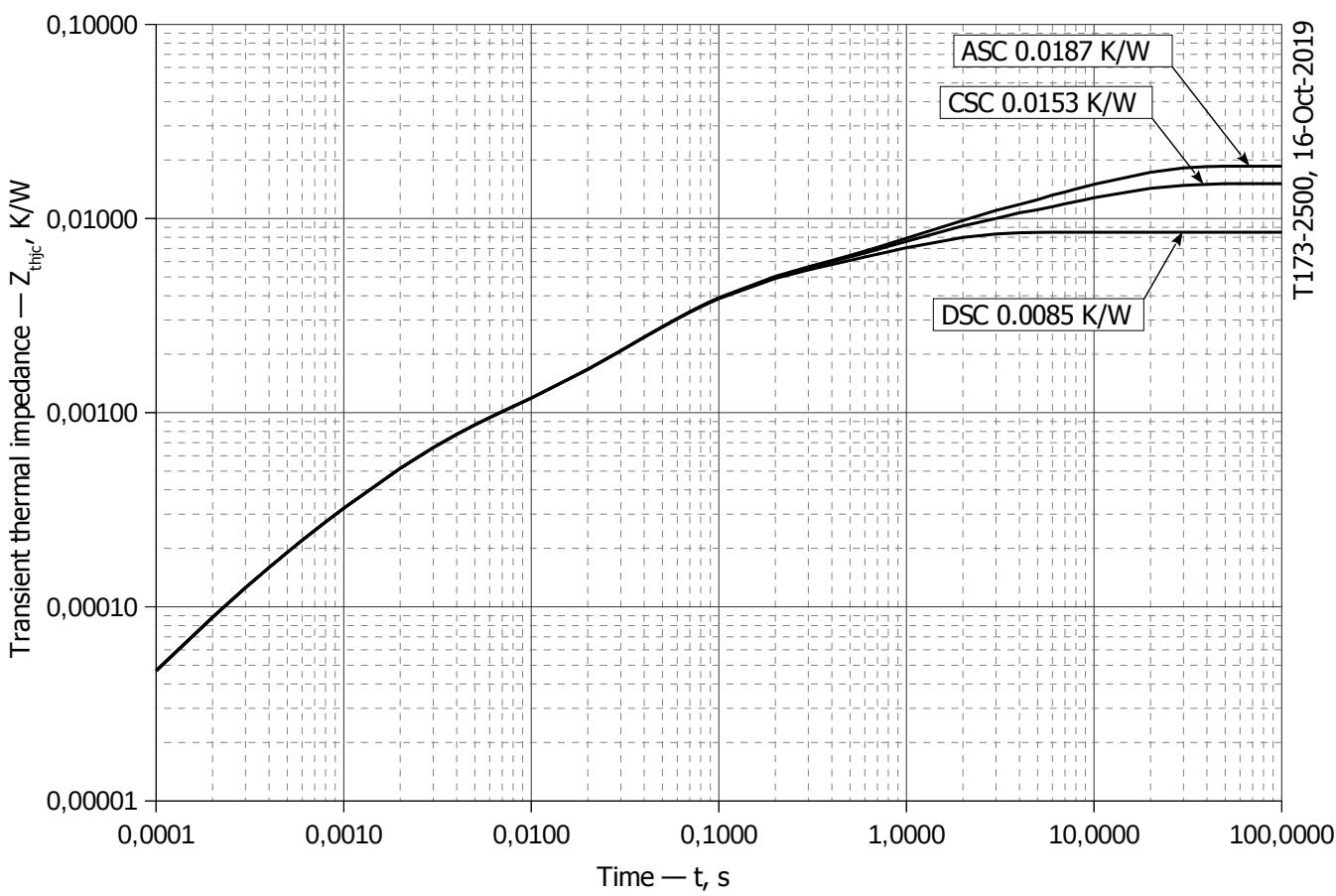


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC Double side cooled

i	1	2	3	4	5	6
R_i , K/W	0.00007989	0.002973	0.0005936	0.000846	0.00005975	0.003948
τ_i , s	1.688	0.06219	0.002329	0.138	0.0003243	0.9533

DC Anode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.01013	0.004062	0.0009401	0.002853	0.0005963	0.00005641
τ_i , s	9.747	1.058	0.1304	0.06179	0.002313	0.0003013

DC Cathode side cooled

i	1	2	3	4	5	6
R_i , K/W	0.006619	0.004034	0.0008595	0.002956	0.0005965	0.00005689
τ_i , s	9.744	1.025	0.1394	0.06237	0.002318	0.0003037

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

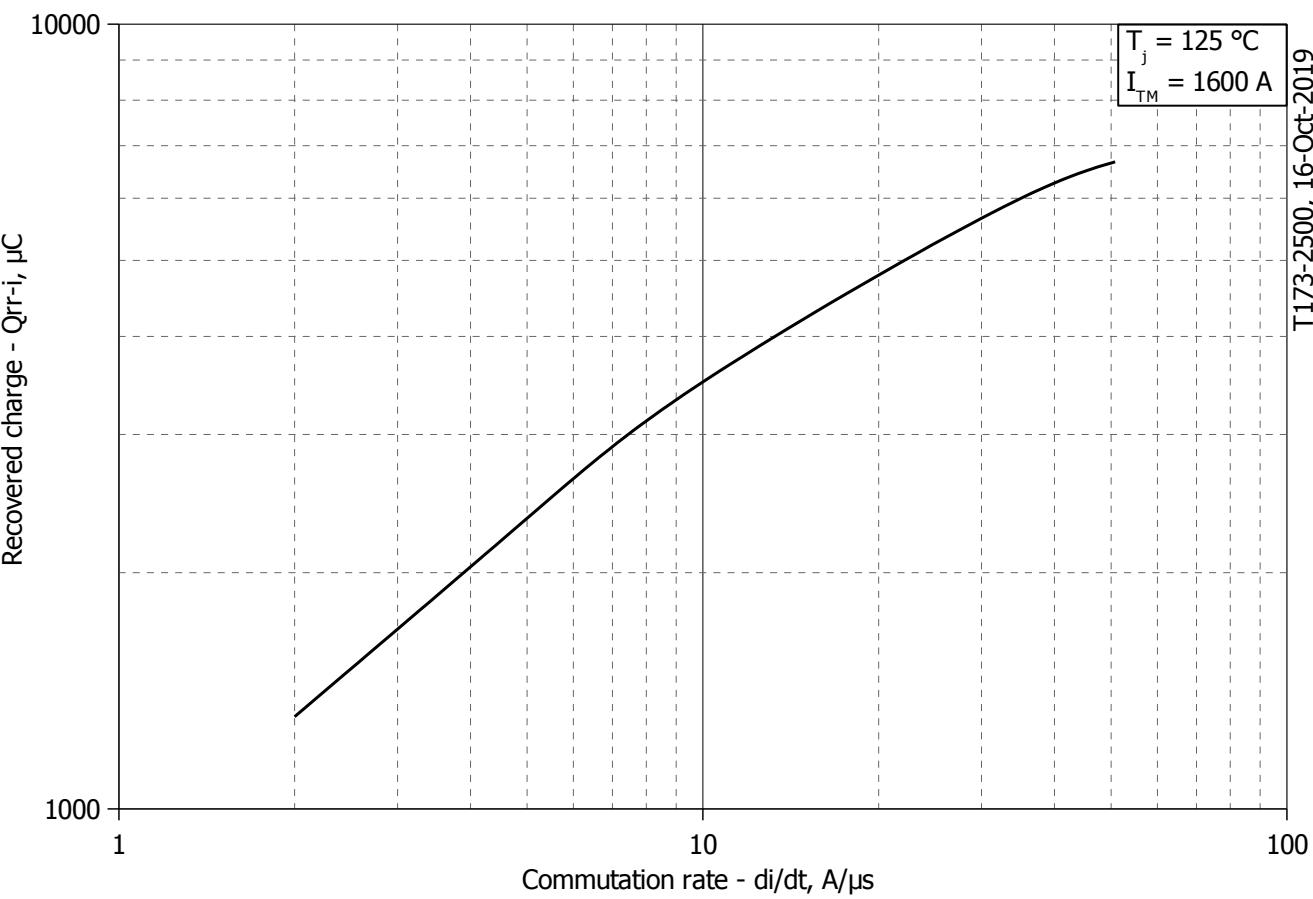


Fig 3 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

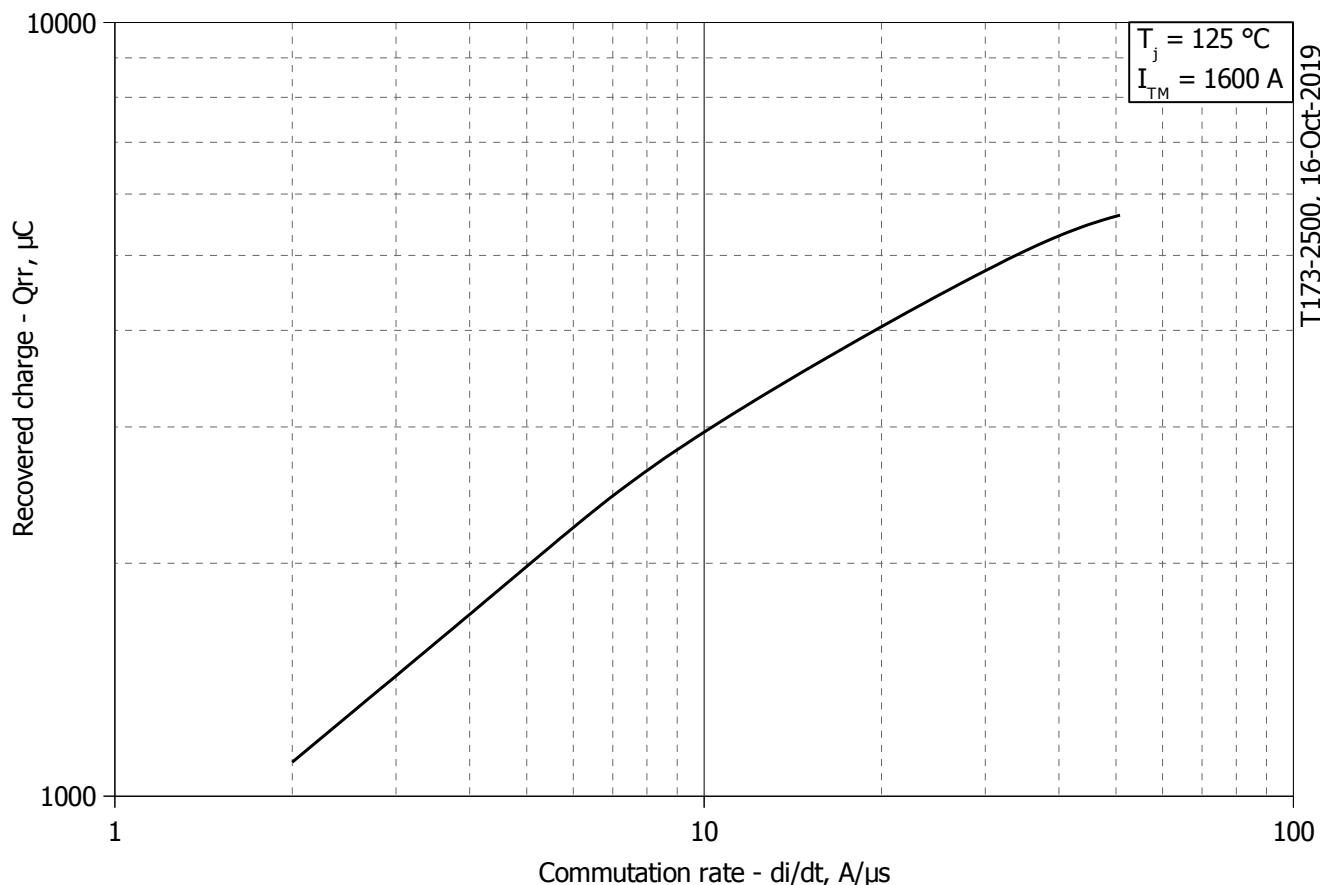


Fig 4 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

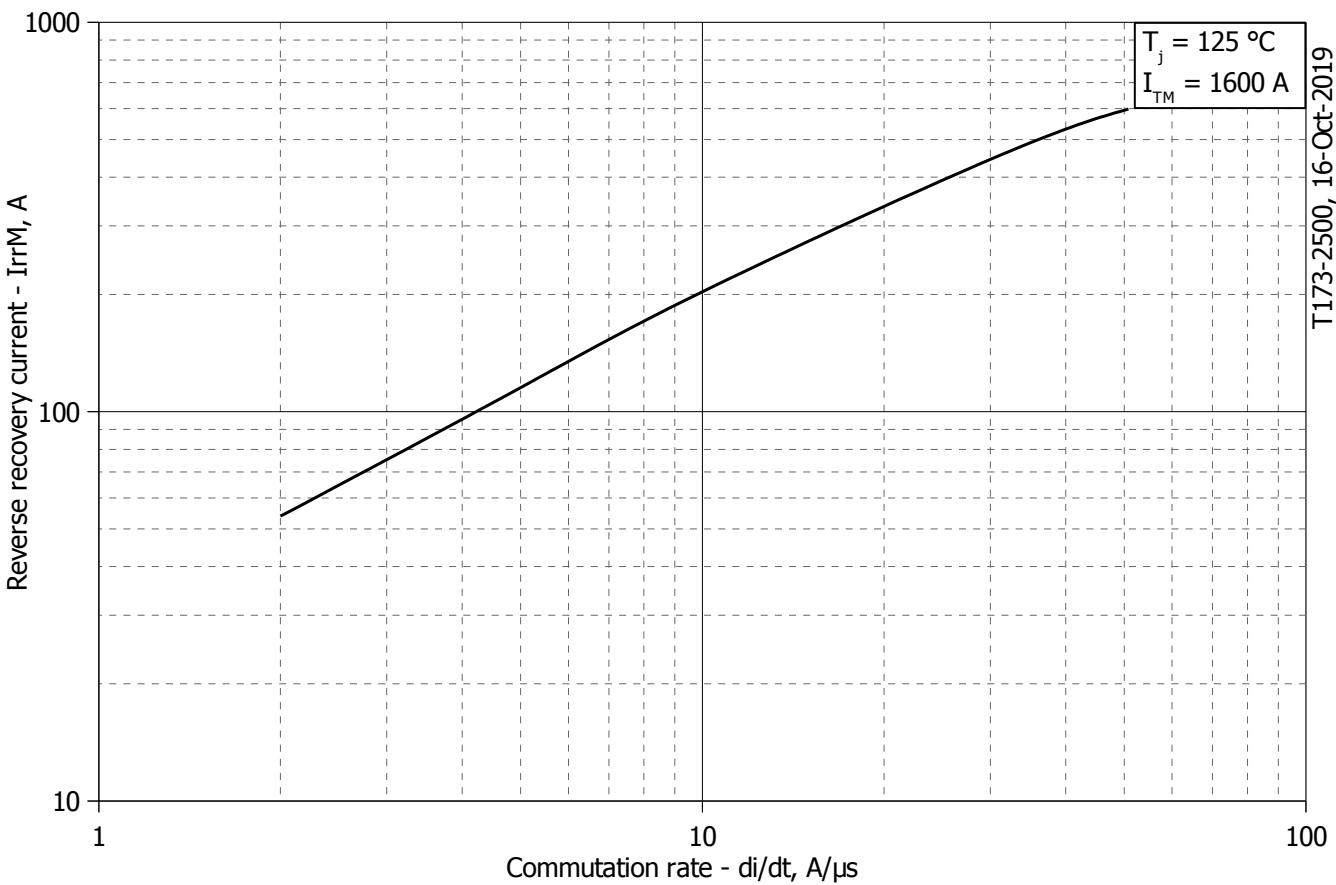


Fig 5 – Maximum reverse recovery current I_{rrM} vs. commutation rate di_R/dt

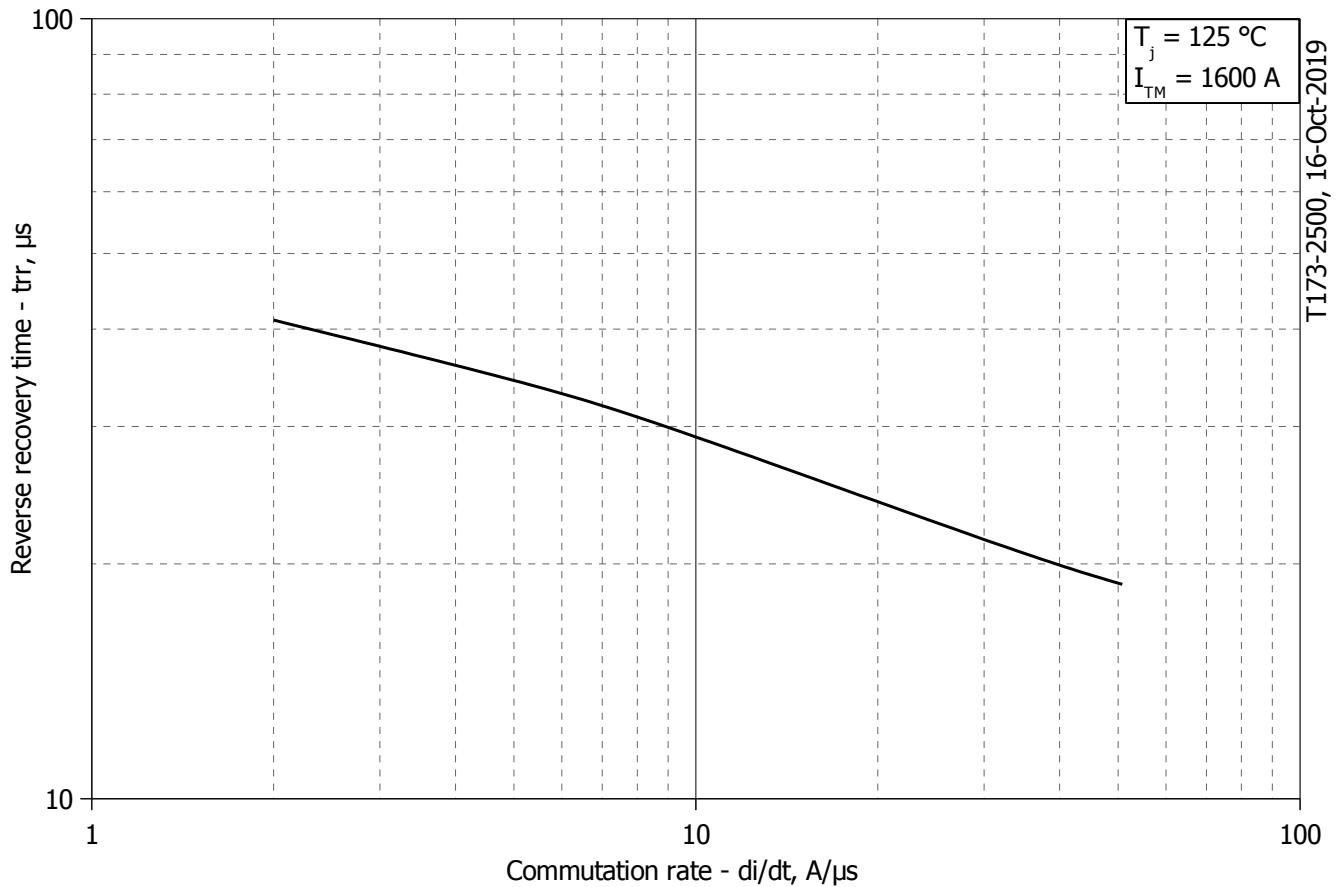


Fig 6 – Maximum recovery time t_{rr} vs. commutation rate di_R/dt (25% chord)

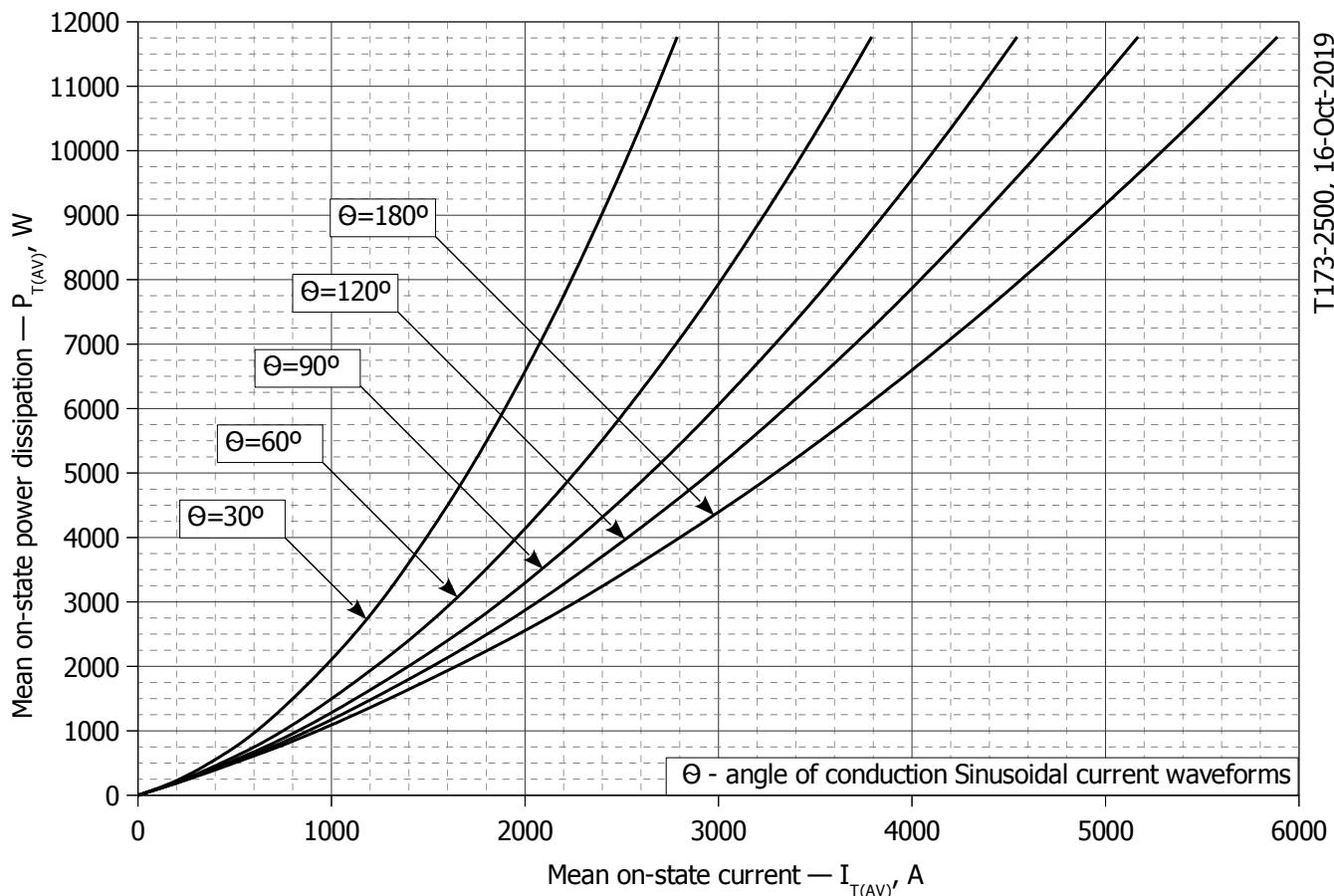


Fig. 7 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

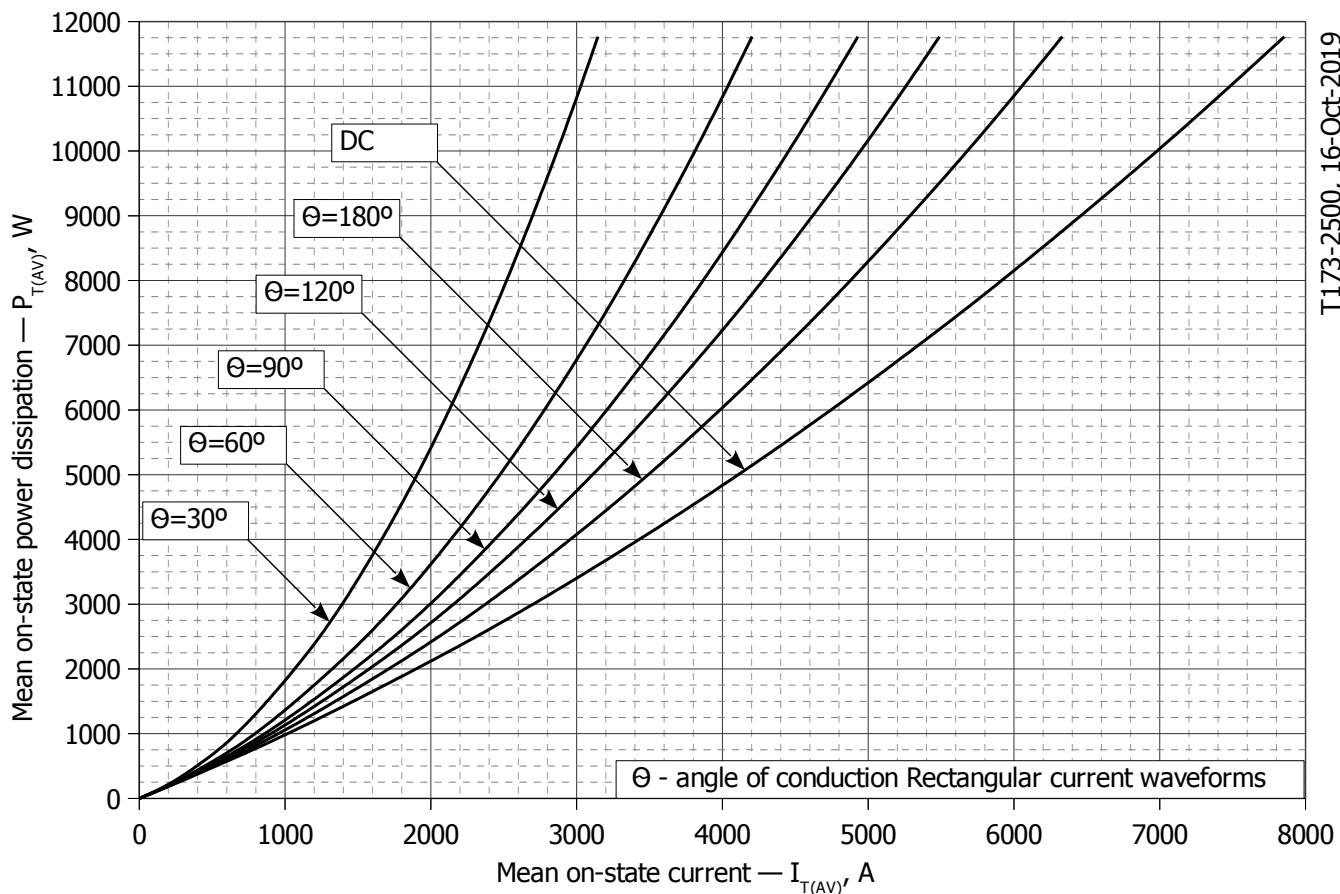


Fig. 8 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

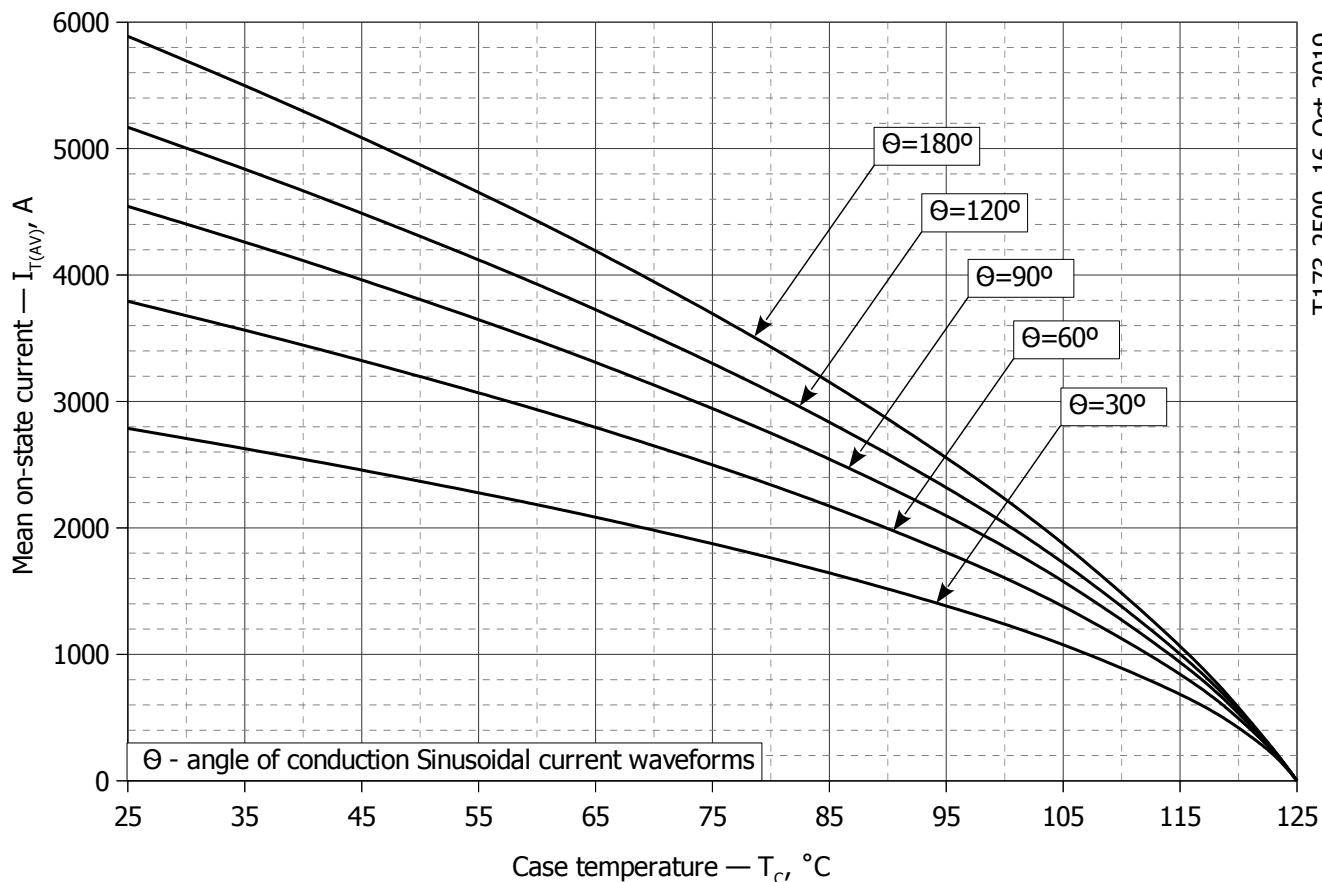


Fig. 9 – Mean on-state current I_{TAV} vs. case temperature T_c for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)

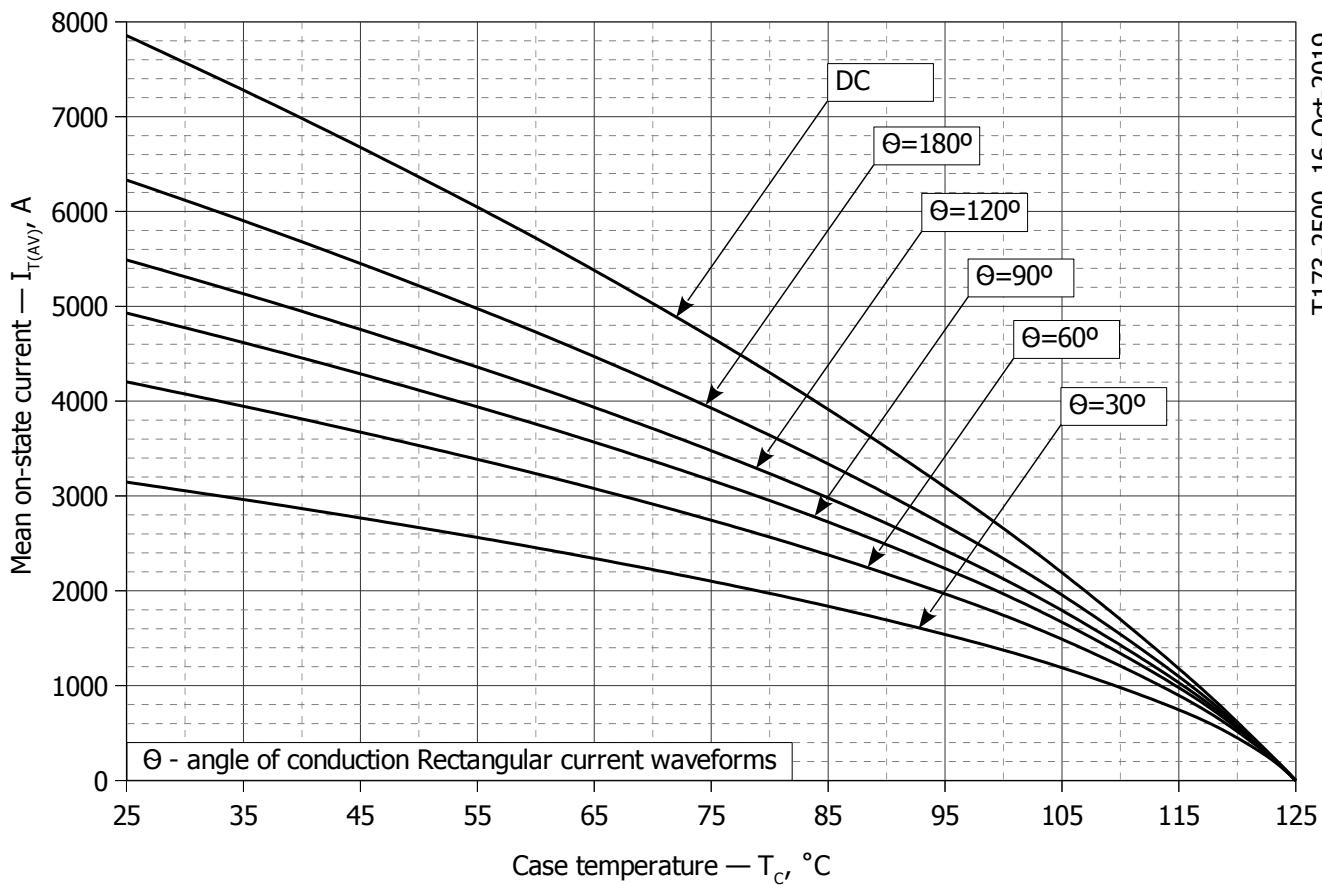


Fig. 10 - Mean on-state current I_{TAV} vs. case temperature T_c for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)

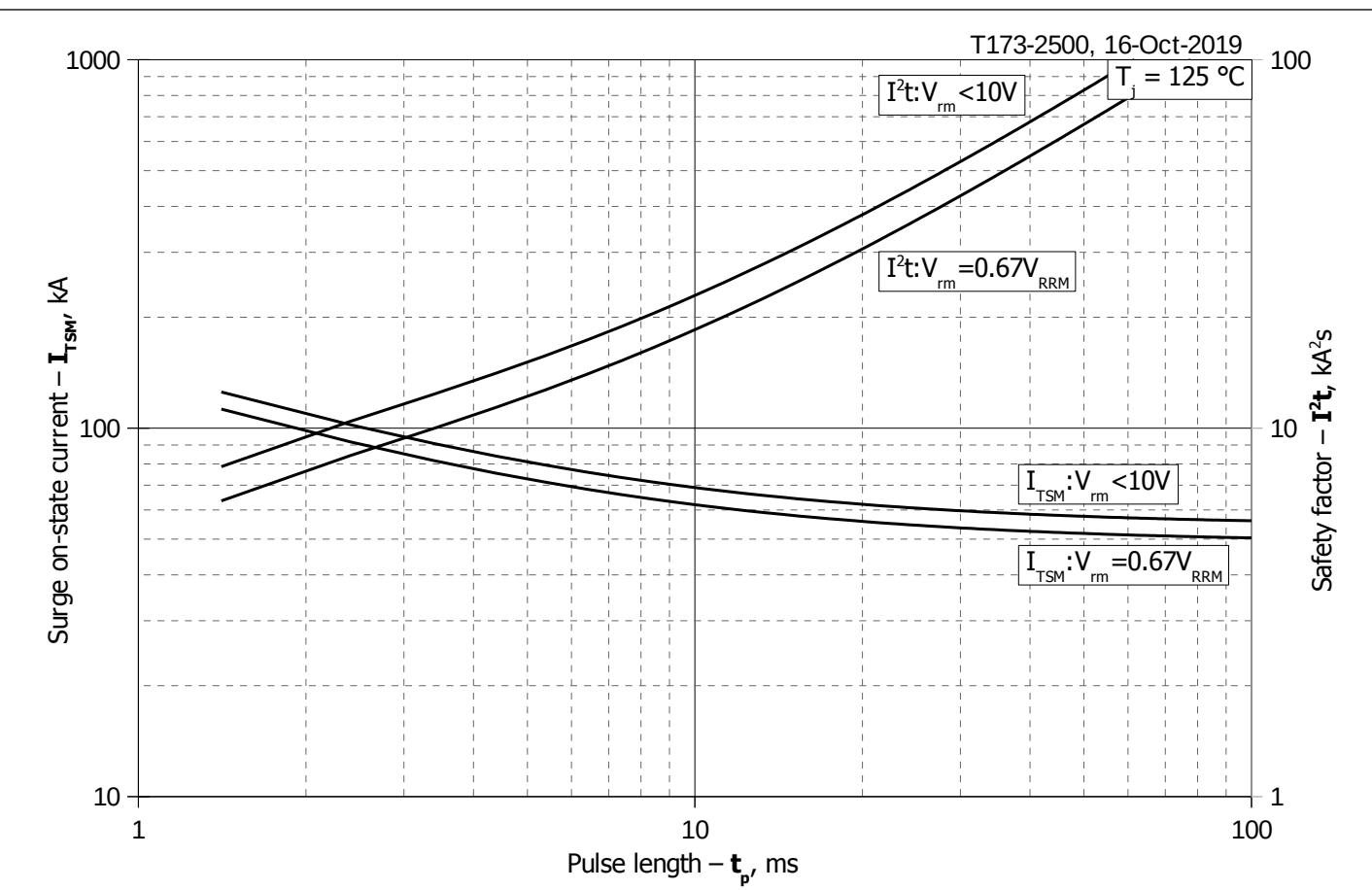


Fig. 11 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

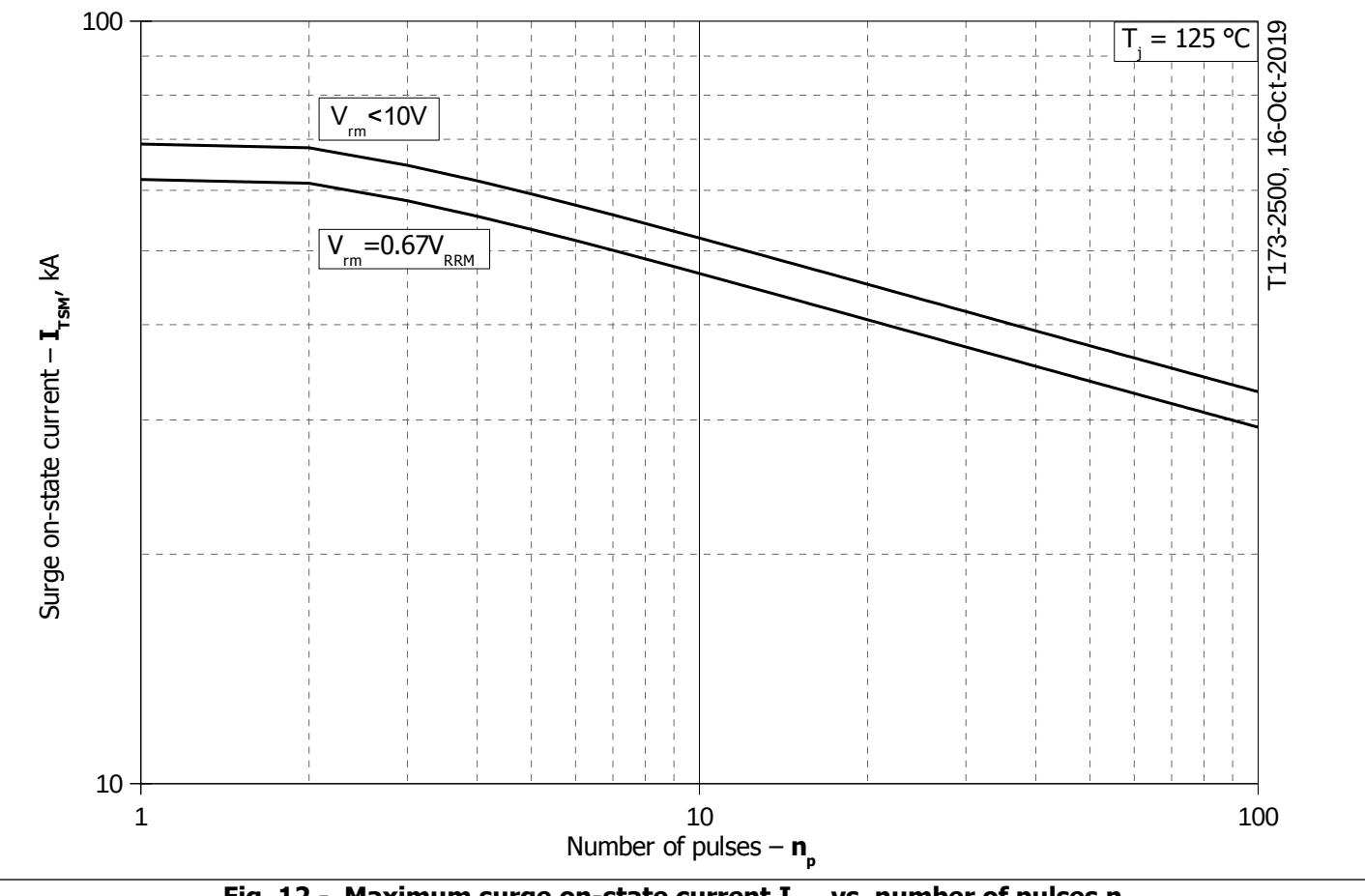


Fig. 12 - Maximum surge on-state current I_{TSM} vs. number of pulses n_p